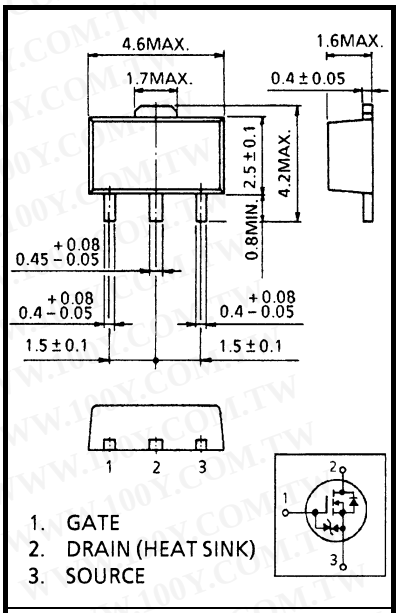
TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π−MOSV)

2SK2549

DC−DC Converter, Relay Drive and Motor Drive Applications

- 2.5-V gate drive
- Low drain−source ON resistance : $R_{DS\ (ON)}$ = 0.29 Ω (typ.)
- High forward transfer admittance : $|Y_{fs}|$ = 3.0 S (typ.)
- Low leakage current : I_{DSS} = 100 μA (max) (V_{DS} = 16 V)
- Enhancement mode : V_{th} = 0.5 to 1.1 V (V_{DS} = 10 V, I_D = 200 μA)

Unit: mm



JEDEC	—
JEITA	—
TOSHIBA	2-5K1B

Weight: 0.05 g (typ.)

Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Drain−source voltage		V_{DSS}	16	V
Drain−gate voltage (R_{GS} = 20 kΩ)		V_{DGR}	16	V
Gate−source voltage		V_{GSS}	±8	V
Drain current	DC (Note 1)	I_D	2	A
	Pulse (Note 1)	I_{DP}	6	
Drain power dissipation		P_D	0.5	W
Drain power dissipation (Note 2)		P_D	1.5	W
Channel temperature		T_{ch}	150	°C
Storage temperature range		T_{stg}	−55 to 150	°C

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: Mounted on a ceramic substrate (25.4 mm × 25.4 mm × 0.8 mm)

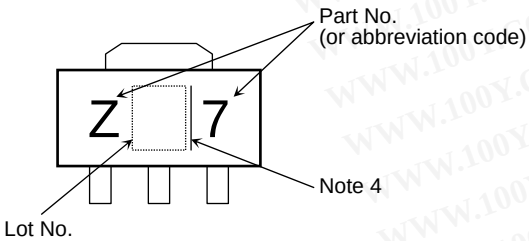
Note 3: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient	$R_{th\ (ch-a)}$	250	°C / W

This transistor is an electrostatic-sensitive device.
Please handle with caution.

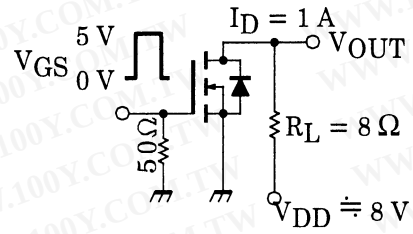
Marking



Note 4: A line to the right of a Lot No. identifies the indication of product Labels.
Without a line: [[Pb]]/INCLUDES > MCV
With a line: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

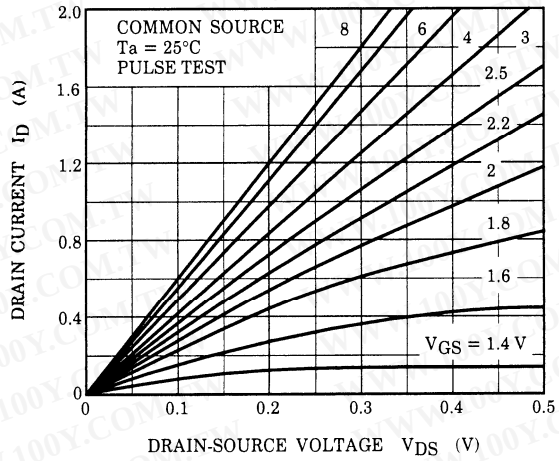
Electrical Characteristics (Ta = 25°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Gate leakage current		I_{GSS}	V_{GS} = ±6.5 V, V_{DS} = 0 V	—	—	±10	μA
Drain cut−off current		I_{DSS}	V_{DS} = 16 V, V_{GS} = 0 V	—	—	100	μA
Drain−source breakdown voltage		$V_{(BR)\ DSS}$	I_D = 10 mA, V_{GS} = 0 V	16	—	—	V
Gate threshold voltage		V_{th}	V_{DS} = 10 V, I_D = 200 μA	0.5	—	1.1	V
Drain−source ON resistance		$R_{DS\ (ON)}$	V_{GS} = 2.5 V, I_D = 0.5 A	—	0.29	0.38	Ω
			V_{GS} = 4 V, I_D = 1 A	—	0.22	0.29	
Forward transfer admittance		$\|Y_{fs}\|$	V_{DS} = 10 V, I_D = 1 A	1.5	3.0	—	S
Input capacitance		C_{iss}	V_{DS} = 10 V, V_{GS} = 0 V, f = 1 MHz	—	260	—	pF
Reverse transfer capacitance		C_{rss}		—	34	—	
Output capacitance		C_{oss}		—	103	—	
Switching time	Rise time	t_r	 Duty ≦ 1%, t_w = 10 μs	—	200	—	ns
	Turn−on time	t_{on}		—	250	—	
	Fall time	t_f		—	300	—	
	Turn−off time	t_{off}		—	800	—	
Total gate charge (Gate−source plus gate−drain)		Q_g	V_{DD} ≈ 16 V, V_{GS} = 5 V, I_D = 2 A	—	5.0	—	nC
Gate−source charge		Q_{gs}		—	3.2	—	
Gate−drain (“miller”) charge		Q_{gd}		—	1.8	—	

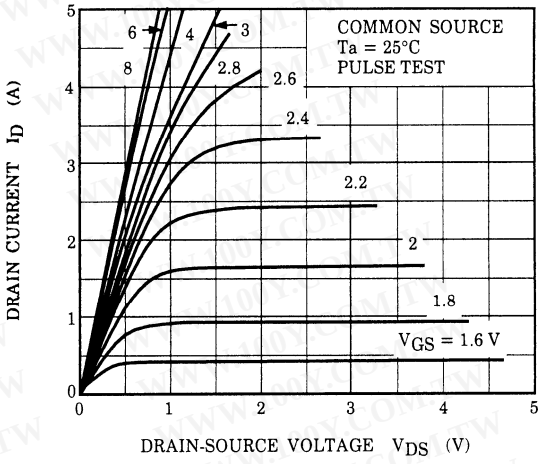
Source−Drain Ratings and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit
Continuous drain reverse current (Note 1)	I_{DR}	—	—	—	2	A
Pulse drain reverse current (Note 1)	I_{DRP}	—	—	—	6	A
Forward voltage (diode)	V_{DSF}	I_{DR} = 2 A, V_{GS} = 0 V	—	—	−1.7	V
Reverse recovery time	t_{rr}	I_{DR} = 2 A, V_{GS} = 0 V dI_{DR} / dt = 50 A / μs	—	220	—	ns
Reverse recovered charge	Q_{rr}		—	0.32	—	μC

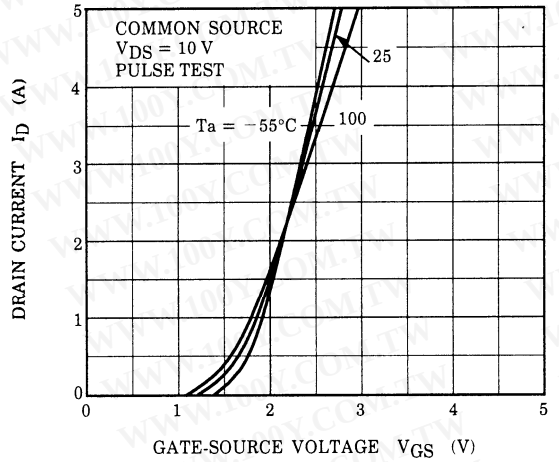
$I_D - V_{DS}$



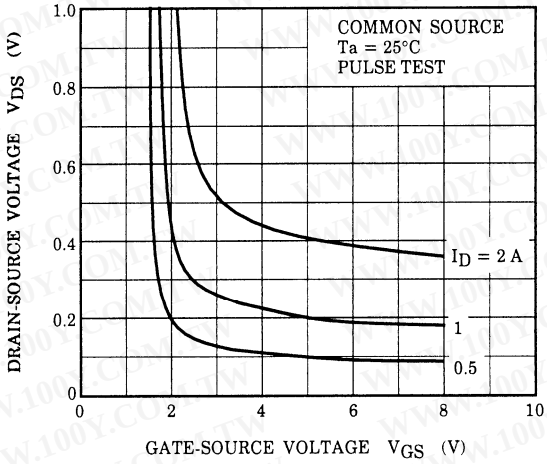
$I_D - V_{DS}$



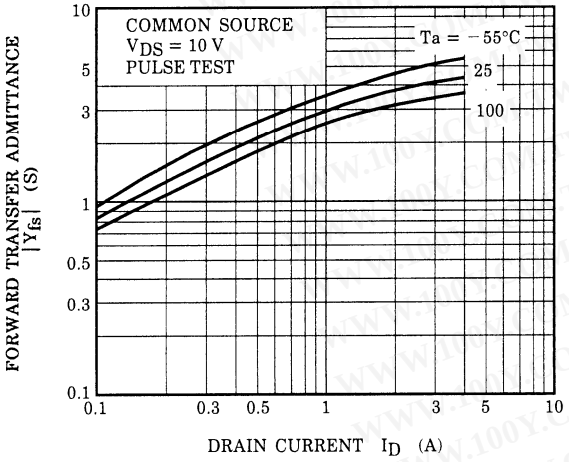
$I_D - V_{GS}$



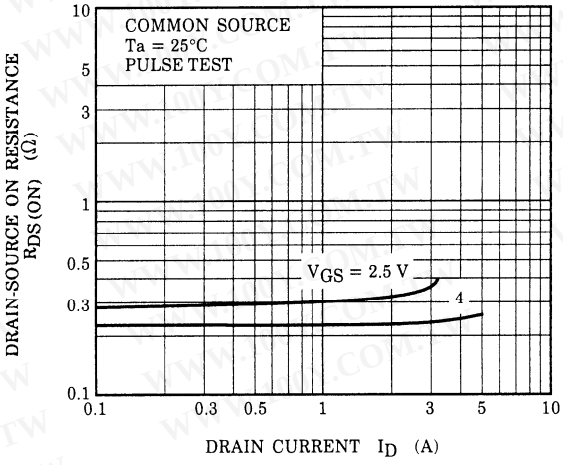
$V_{DS} - V_{GS}$



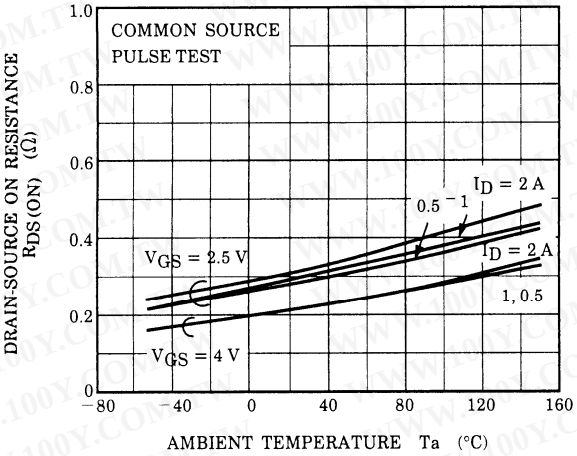
$|Y_{fs}| - I_D$



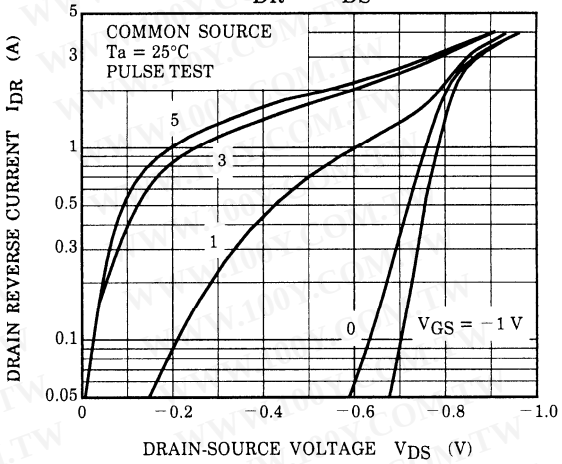
$R_{DS\,(ON)} - I_D$



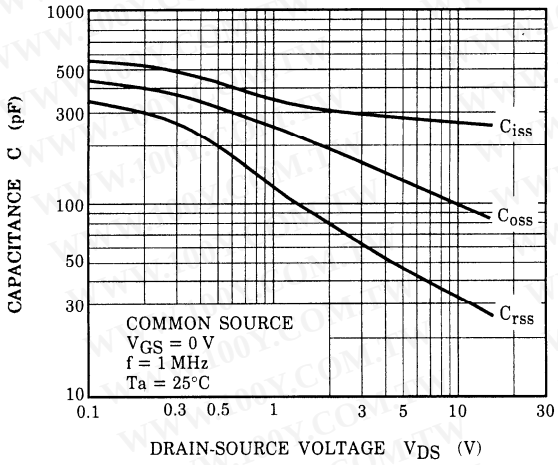
$R_{DS\,(ON)}$ – Ta



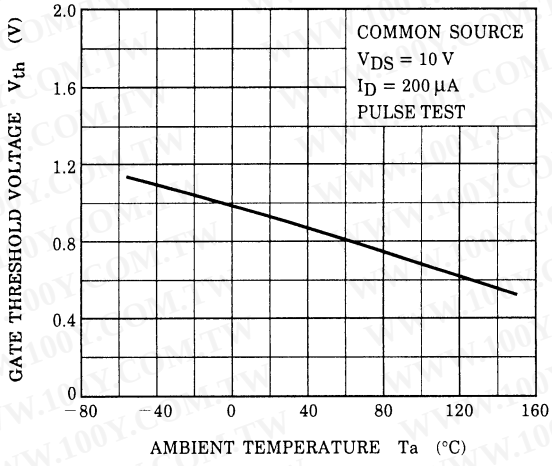
I_{DR} – V_{DS}



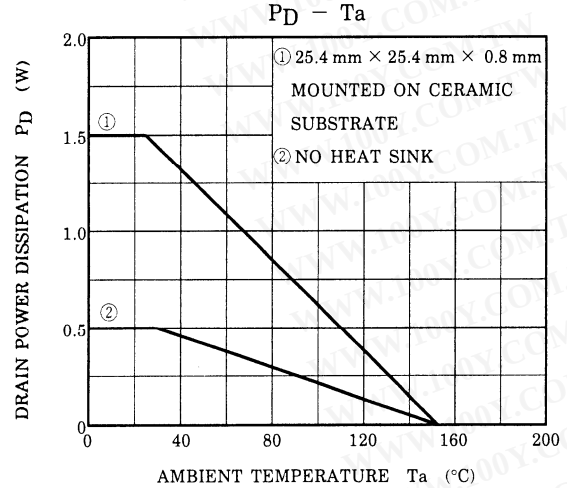
CAPACITANCE – V_{DS}

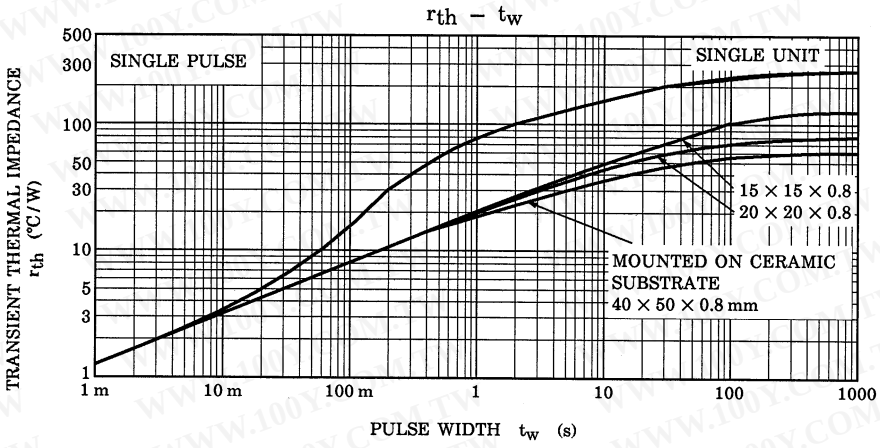


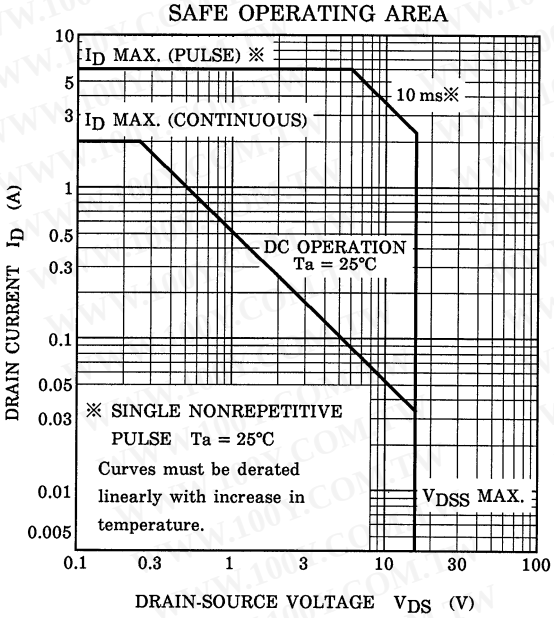
V_{th} – Ta



P_D – Ta







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